

10/564857

APPLICATION DATA SHEET

17 JAN 2006

Electronic Version v14

Stylesheet Version v14.1

*Applicant Information:*Inventor 1:

Applicant Authority Type:	Inventor
Citizenship:	JP
Given Name:	Eiichi
Family Name:	KAWAMOTO
City of Residence:	Fukuyama-shi, Hiroshima
Country of Residence:	JP
Address-1 of Mailing Address:	3-1, Kasugadai
Address-2 of Mailing Address:	
City of Mailing Address:	Fukuyama-shi, Hiroshima
State of Mailing Address:	
Postal Code of Mailing Address:	721-0916
Country of Mailing Address:	JP
Phone:	
Fax:	
E-mail:	

Correspondence Information:

Customer Number:	22204	*22204*
------------------	-------	---------

Application Information:

Title of Invention:	SUCTION DEVICE AND NOZZLE DEVICE
Application Type:	regular, utility
Attorney Docket Number:	740169-46

Botanic Information:

Publication Information:

Suggested Figure for Publication -
Suggested Classification -
Suggested Technology Center -
Total Number of Drawing Sheets -

Representative Information:

practitioner(s) at Customer Number:

22204 *22204*

as my attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

Domestic Priority Information:

This is a National Stage of US application number PCT/JP2004/010396, filed 2004-07-22, now Pending.

Foreign Priority Information:

Doc.No:2003-283109; Country - JP; Date: 2003-07-30 us-priority-claimed

Assignee Information:

Assignee 1:

Organization Name: SANKYO AQUA SYSTEM CO., LTD.

Address-1 of Mailing Address: 4-8-14, Akasaka

Address-2 of Mailing Address:

City of Mailing Address: Minato-ku, Tokyo

State of Mailing Address:

Postal Code of Mailing Address: 107-0052

Country of Mailing Address: JP

Phone:

Fax:

E-mail:

Assignee 2:

Organization Name: Eiichi KAWAMOTO
Address-1 of Mailing Address: 3-1, Kasugadai
Address-2 of Mailing Address:
City of Mailing Address: Fukuyama-shi, Hiroshima
State of Mailing Address:
Postal Code of Mailing Address: 721-0916
Country of Mailing Address: JP
Phone:
Fax:
E-mail: